



512Kx8 MONOLITHIC SRAM, SMD 5962-95613

EVOLUTIONARY PINOUT

32 DIP
32 CSOJ (DE)

TOP VIEW

A18	1	32	Vcc
A16	2	31	A15
A14	3	30	A17
A12	4	29	\overline{WE}
A7	5	28	A13
A6	6	27	A8
A5	7	26	A9
A4	8	25	A11
A3	9	24	\overline{OE}
A2	10	23	A10
A1	11	22	CS
A0	12	21	I/O7
I/O0	13	20	I/O6
I/O1	14	19	I/O5
I/O2	15	18	I/O4
GND	16	17	I/O3

PIN DESCRIPTION

A0-18	Address Inputs
I/O0-7	Data Input/Output
\overline{CS}	Chip Select
\overline{OE}	Output Enable
\overline{WE}	Write Enable
Vcc	+5.0V Power
GND	Ground

FEATURES

- Access Times 70, 85, 100, 120ns
- MIL-STD-883 Compliant Devices Available
- Evolutionary, Corner Power/Ground Pinout
JEDEC Approved
 - 32 pin Ceramic DIP (Package 300)
 - 32 lead Ceramic SOJ (Package 101)
- Commercial, Industrial and Military Temperature Ranges
- 5 Volt Power Supply
- Low Power CMOS
- Low Power Data Retention
- TTL Compatible Inputs and Outputs



ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Min	Max	Unit
Operating Temperature	T _A	-55	+125	°C
Storage Temperature	T _{STG}	-65	+150	°C
Signal Voltage Relative to GND	V _G	-0.5	V _{CC} +0.5	V
Junction Temperature	T _J		150	°C
Supply Voltage	V _{CC}	-0.5	7.0	V

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Min	Max	Unit
Supply Voltage	V _{CC}	4.5	5.5	V
Input High Voltage	V _{IH}	2.2	V _{CC} + 0.3	V
Input Low Voltage	V _{IL}	-0.3	+0.8	V
Operating Temp. (Mil.)	T _A	-55	+125	°C

TRUTH TABLE

\overline{CS}	\overline{OE}	\overline{WE}	Mode	Data I/O	Power
H	X	X	Standby	High Z	Standby
L	L	H	Read	Data Out	Active
L	X	L	Write	Data In	Active
L	H	H	Out Disable	High Z	Active

CAPACITANCE (T_A = +25°C)

Parameter	Symbol	Condition	Max	Unit
Input capacitance	C _{IN}	V _{IN} = 0V, f = 1.0MHz	12	pF
Output capacitance	C _{OUT}	V _{OUT} = 0V, f = 1.0MHz	12	pF

This parameter is guaranteed by design but not tested.

DC CHARACTERISTICS (V_{CC} = 5.0V, GND = 0V, T_A = -55°C TO +125°C)

Parameter	Symbol	Conditions	MinMax		Units
Input Leakage Current	I _{LI}	V _{CC} = 5.5, V _{IN} = GND to V _{CC}		10	μA
Output Leakage Current	I _{LO}	\overline{CS} = V _{IH} , \overline{OE} = V _{IH} , V _{OUT} = GND to V _{CC}		10	μA
Operating Supply Current	I _{CC}	\overline{CS} = V _{IL} , \overline{OE} = V _{IH} , f = 5MHz, V _{CC} = 5.5		50	mA
Standby Current	I _{SB}	\overline{CS} = V _{IH} , \overline{OE} = V _{IH} , f = 5MHz, V _{CC} = 5.5		1	mA
Output Low Voltage	V _{OL}	I _{OL} = 2.1mA, V _{CC} = 4.5		0.4	V
Output High Voltage	V _{OH}	I _{OH} = -1.0mA, V _{CC} = 4.5	2.4		V

NOTE: DC test conditions: V_{IH} = V_{CC} - 0.3V, V_{IL} = 0.3V

DATA RETENTION CHARACTERISTICS (T_A = -55°C TO +125°C)

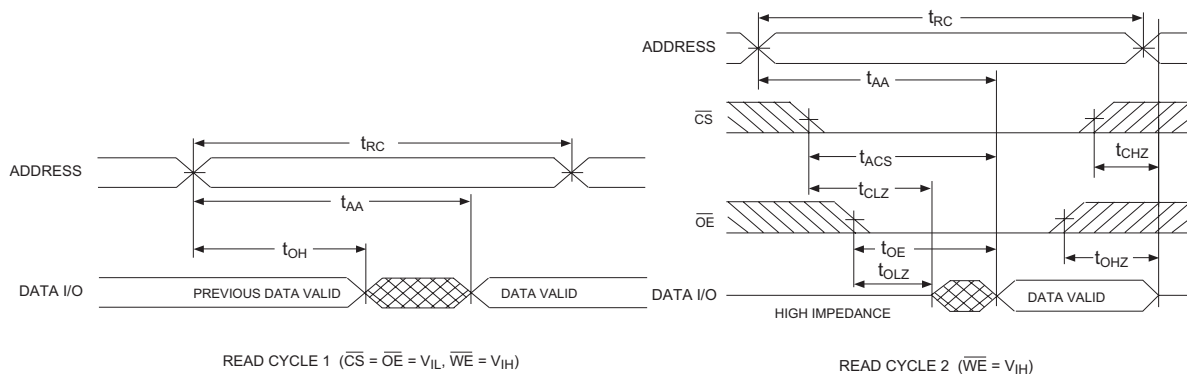
Parameter	Symbol	Conditions	Military Typ			Units
			Min		Max	
Data Retention Supply Voltage	V _{DR}	$\overline{CS} \geq V_{CC} - 0.2V$	2.0		5.5	V
Data Retention Current	I _{CCDR1}	V _{CC} = 3V		100	400	μA

DATA RETENTION CHARACTERISTICS FOR LOW POWER “L” VERSION

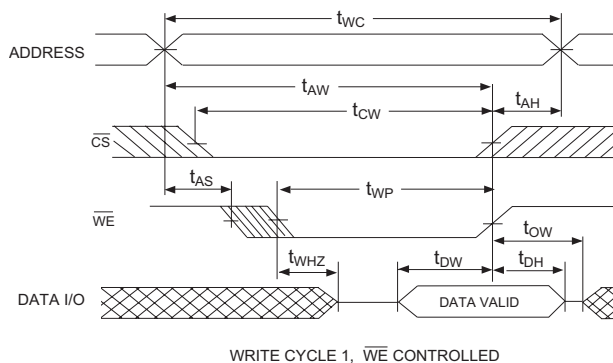
Parameter	Symbol	Conditions	Min		Max	Units
Data Retention Supply Voltage	V _{DR}	$\overline{CS} \geq V_{CC} - 0.2V$	2.0		5.5	V
Low Power Data Retention (L)	I _{CCDR1}	V _{CC} = 2V			185	μA



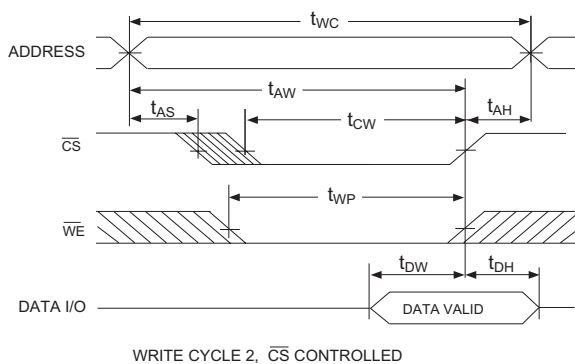
TIMING WAVEFORM - READ CYCLE



WRITE CYCLE - \overline{WE} CONTROLLED

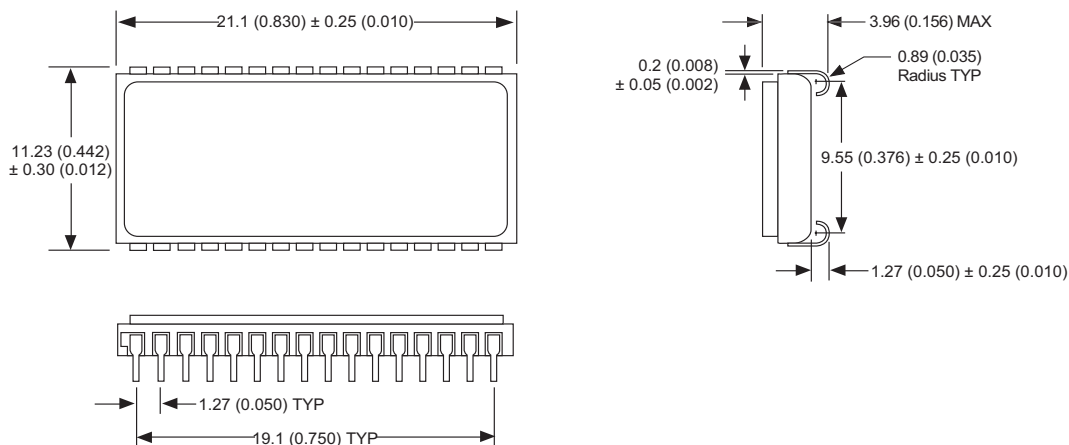


WRITE CYCLE - \overline{CS} CONTROLLED



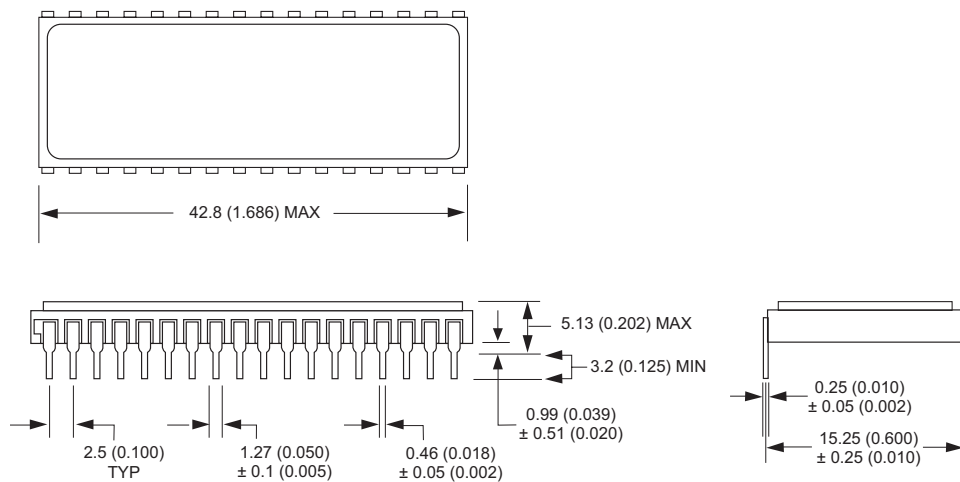


PACKAGE 101: 32 LEAD, CERAMIC SOJ



ALL LINEAR DIMENSIONS ARE MILLIMETERS AND PARENTHETICALLY IN INCHES

PACKAGE 300: 32 PIN, CERAMIC DIP, SINGLE CAVITY SIDE BRAZED



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ORDERING INFORMATION

W M S 512K 8 L - XXX X X X X

LEAD FINISH:

Blank = Gold plated leads

A = Solder dip leads

SPECIAL PROCESSING:

E = Epitaxial Layer

DEVICE GRADE:

M = Military Screened -55°C to +125°C

I = Industrial -40°C to +85°C

C = Commercial 0°C to +70°C

PACKAGE:

C = 32 Pin Ceramic 0.600" DIP (Package 300)

DE = 32 Lead Ceramic SOJ (Package 101) Evolutionary

ACCESS TIME (ns)

IMPROVEMENT MARK

L = Low Power Data Retention

ORGANIZATION, 512K x 8

SRAM

MONOLITHIC

WHITE ELECTRONIC DESIGNS

DEVICE TYPE	SPEED	PACKAGE	SMD NO.
512K x 8 SRAM Monolithic	120ns	32 pin DIP (C)	5962-95613 01HYX
512K x 8 SRAM Monolithic	100ns	32 pin DIP (C)	5962-95613 02HYX
512K x 8 SRAM Monolithic	85ns	32 pin DIP (C)	5962-95613 03HYX
512K x 8 SRAM Monolithic	70ns	32 pin DIP (C)	5962-95613 04HYX
512K x 8 SRAM Monolithic	120ns	32 lead SOJ Evol (DE)	5962-95613 01HTX
512K x 8 SRAM Monolithic	100ns	32 lead SOJ Evol (DE)	5962-95613 02HTX
512K x 8 SRAM Monolithic	85ns	32 lead SOJ Evol (DE)	5962-95613 03HTX
512K x 8 SRAM Monolithic	70ns	32 lead SOJ Evol (DE)	5962-95613 04HTX